

Project: IEEE P802.15 Working Group for Wireless Personal Area Networks (WPANs)

Submission Title: [The Low-cost RF-CMOS 60-GHz Transceiver]

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Abstract: [Description of the low-cost of RF-CMOS RFIC development]

Purpose: [Contribution to TG3c at March 2007 meeting.]

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The Low-Cost RF-CMOS 60-GHz Transceiver

**Tian-Wei Huang, Chi-Hsueh Wang, Hong-Yeh Chang*,
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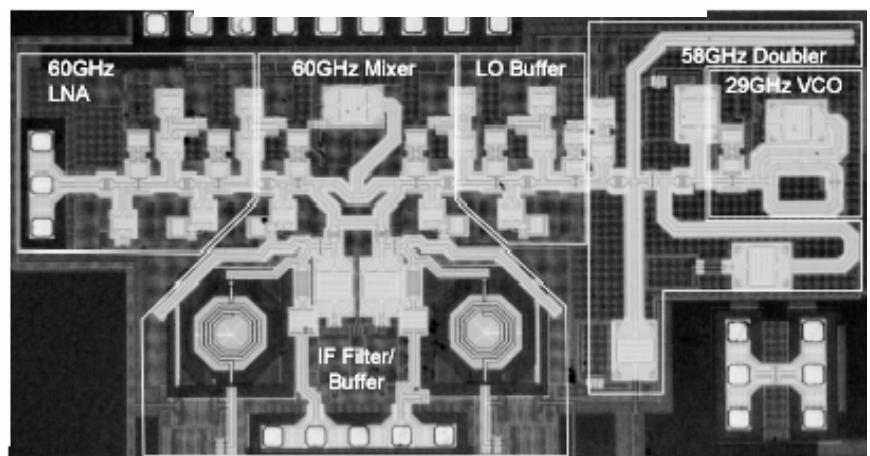
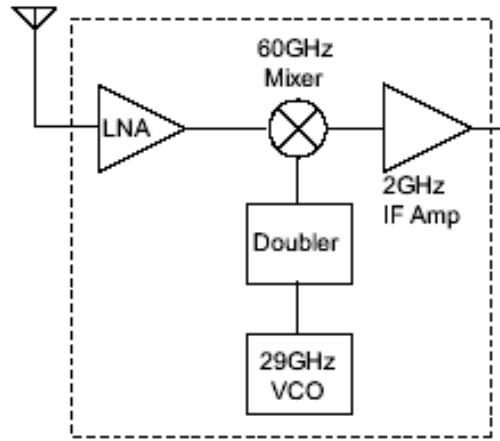
March 13, 2007

Agenda

- **CMOS Low-power Transceiver**
 - **Low-power Tx**
 - **Low-power Rx**
- **CMOS Active Mixer**

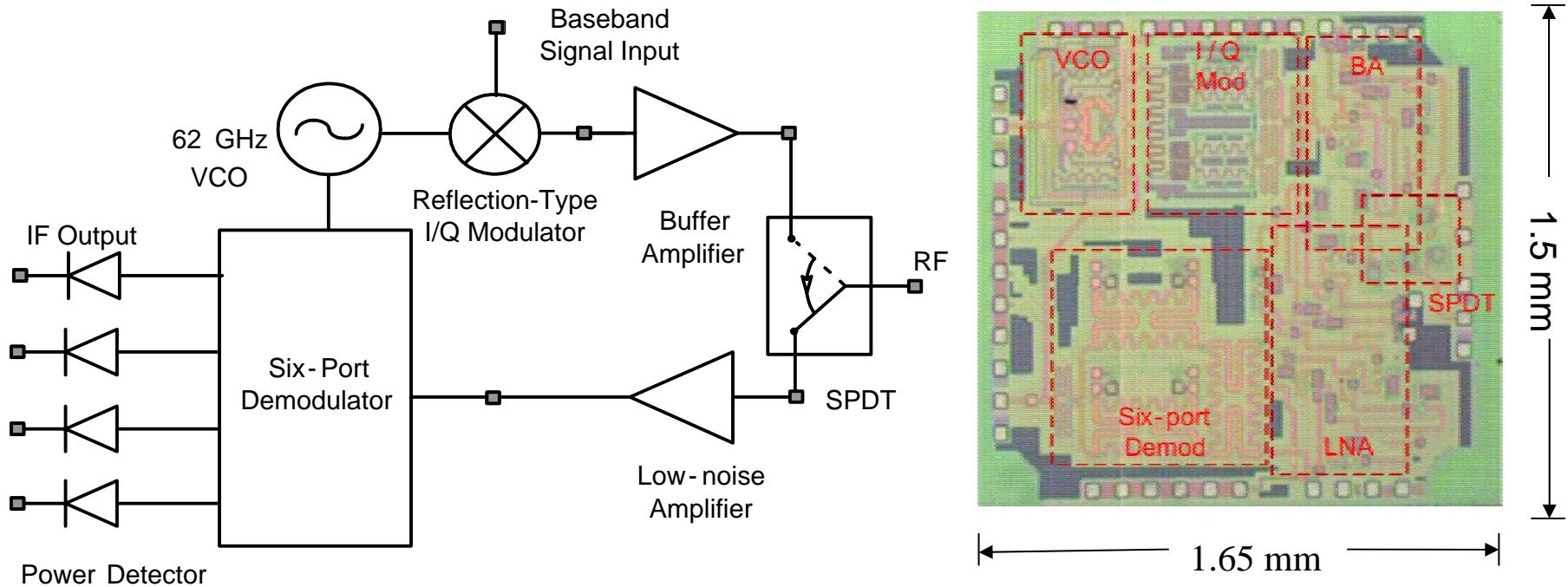
Publication Review (60-GHz Rx)

- Technology: 0.13 μ m CMOS technology
- Chip size: 3.8 mm²
- VCO+Doubler: +2dBm@59GHz,
-86dBc/Hz@1MHz offset
- Mixer: CG > -2dB@60GHz, P_{LO}=0dBm
- DC power consumption: 77mW



Sohrab Emami, Chinh H. Doan, Ali M. Niknejad, and Robert W. Brodersen, "A Highly Integrated 60GHz CMOS Front-End Receiver," 2007 *International Solid-State Circuit Conference (ISSCC)*, San Francisco, CA, Feb. 2007.

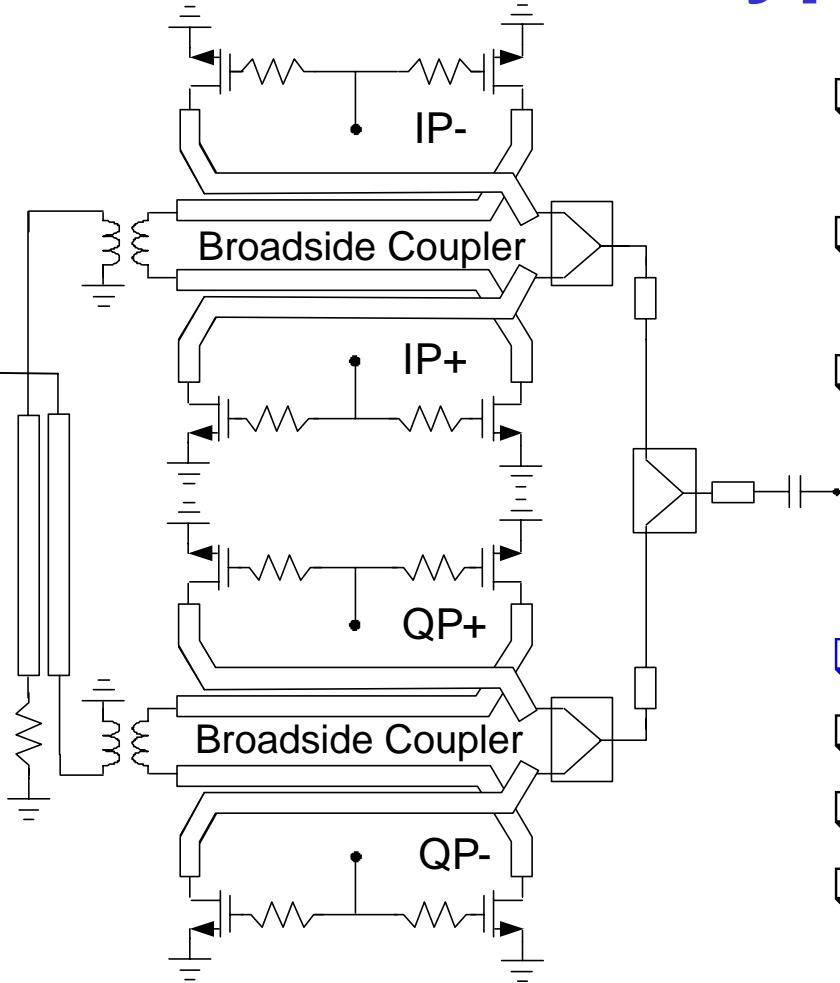
The Low-power Transceiver Structure



- 0.13 μm CMOS, Low power consumption, and Low LO power
- Miniature chip size, and Low Cost

C-H. Wang, H-Y. Chang, P-S. Wu, K-Y. Lin, T-W. Huang, H. Wang, C-H. Chen, "A 60GHz Low-Power Six-Port Transceiver for Gigabit Software-Defined Transceiver Applications," 2007 International Solid-State Circuit Conference (ISSCC), San Francisco, CA, Feb. 2007.

Reflection-Type I/Q Modulator

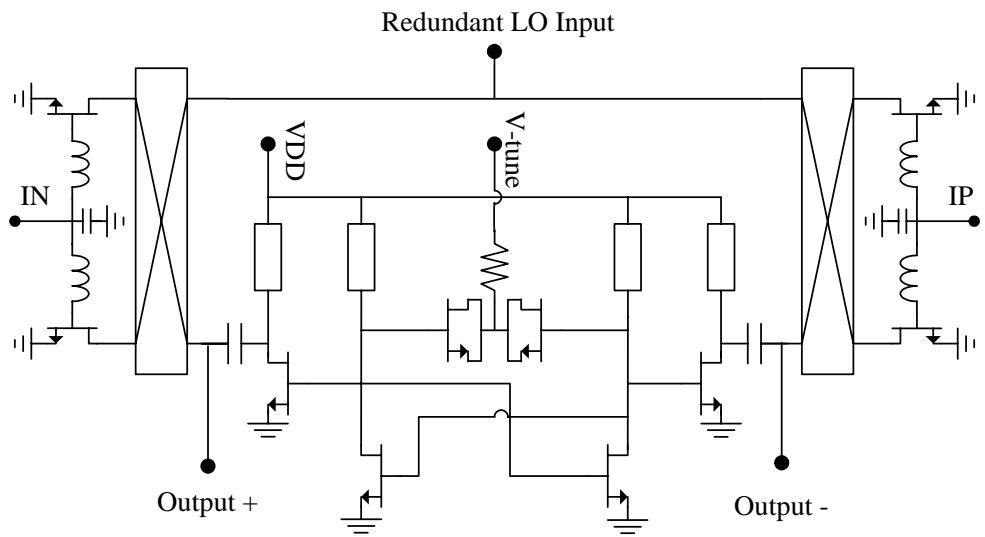
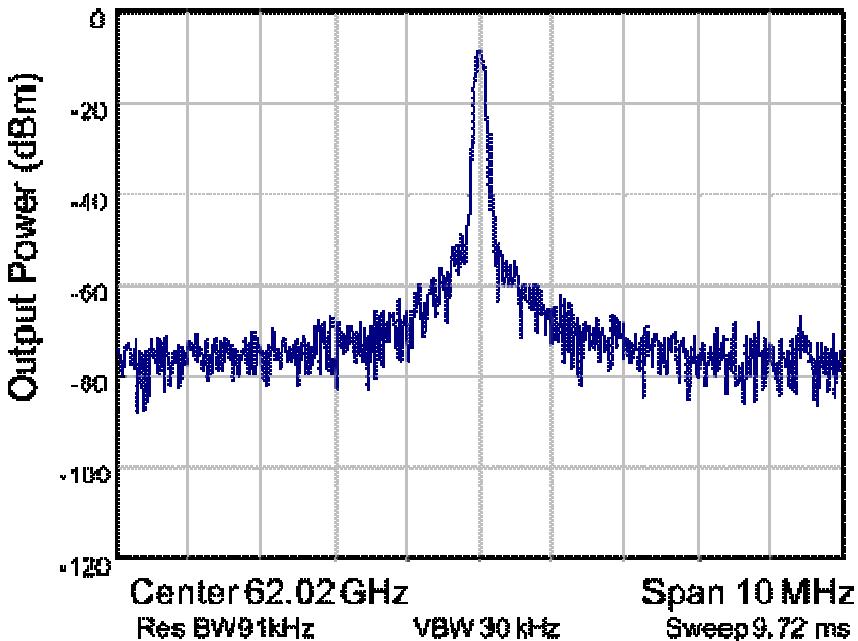


- Meandered broadside coupler to implement 90° hybrids.
 - Marchand-type transformer to implement the 180° hybrid.
 - Wilkinson power combiner for in-phase combiner
-
- **Low LO drive power**
 - Low DC power consumption
 - High linearity, broad Bandwidth
 - I/Q modulation

Hong-Yeh Chang, and et al, "Design and analysis of CMOS broad-band compact high-linearity modulators for gigabit microwave/millimeter-wave applications," *IEEE Transactions on Microwave Theory and Techniques*, Jan. 2006.

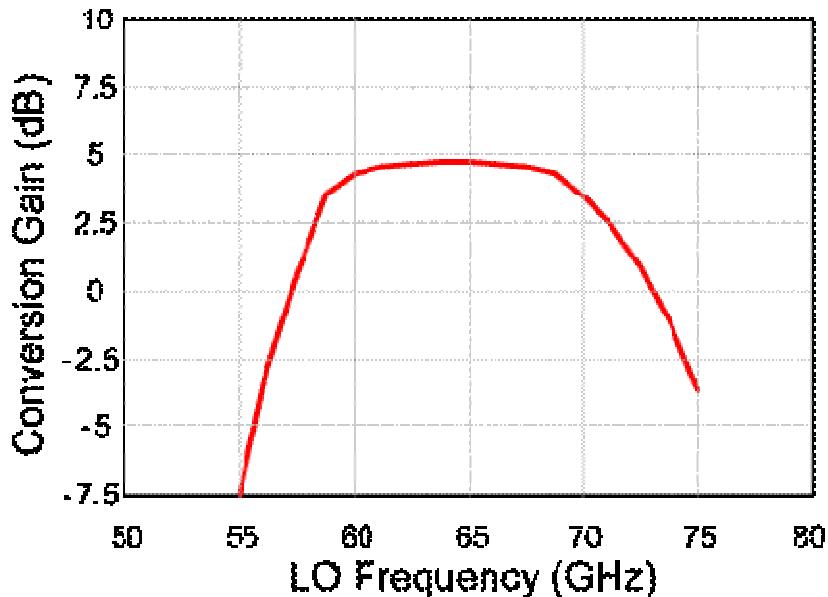
VCO Design and Testing

Measured Output Spectrum

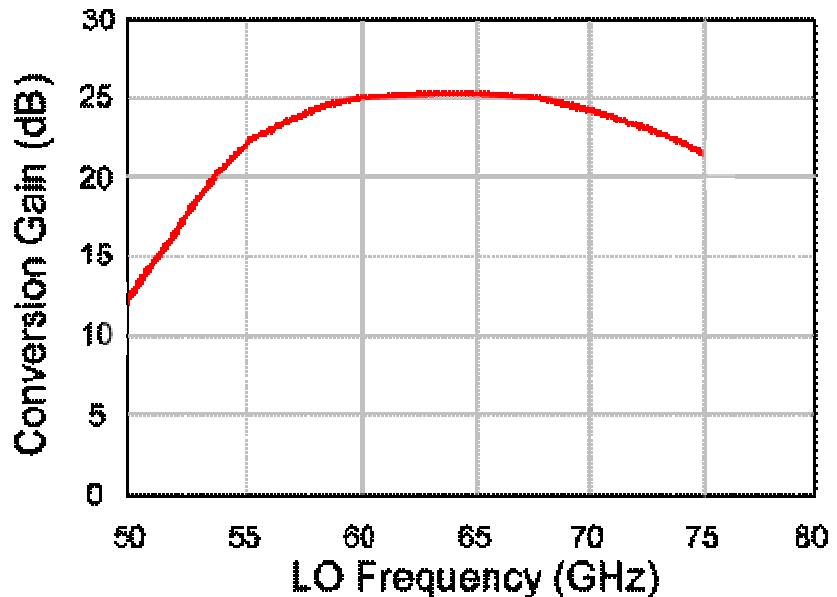


- Phase noise: -92.2 dBc/Hz @ 1MHz offset at 62 GHz
- Output power at the test port: -12.1 dBm

Measured Transmitter Conversion Gain



Low Gain Mode

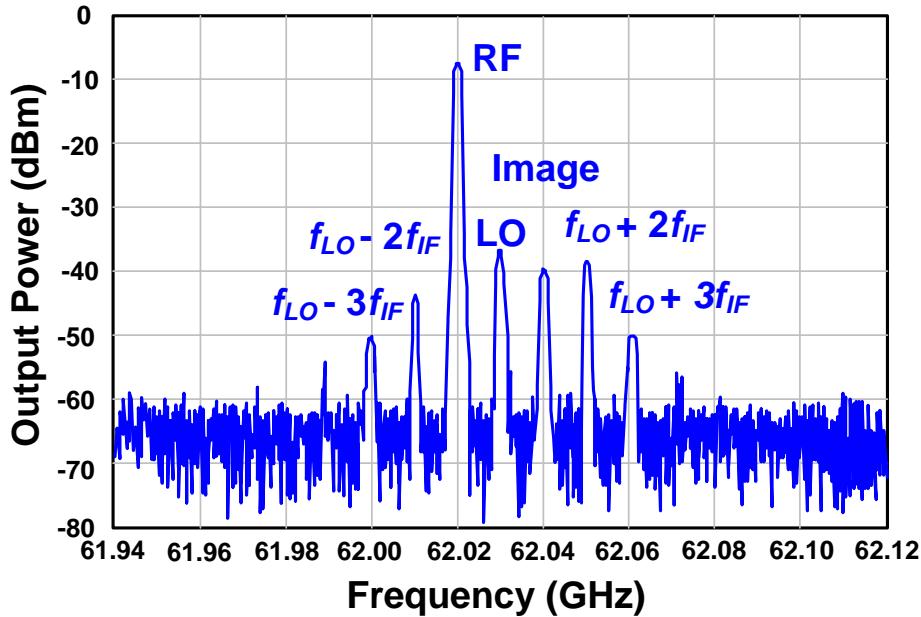


High Gain Mode

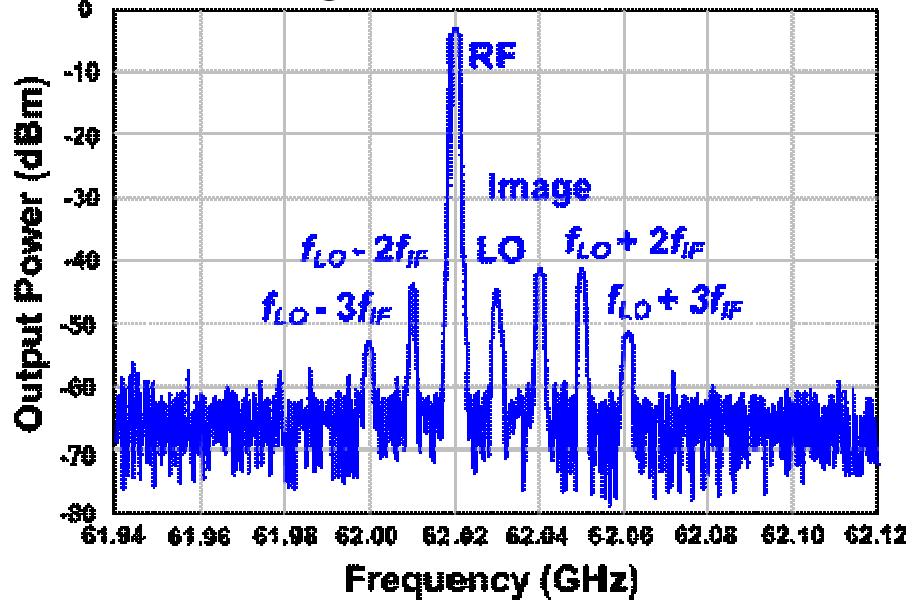
- ❑ Conversion gain : 4-5dB at low gain mode, (60-68 GHz)
- ❑ Conversion gain : 24-25dB at high gain mode, (57-70 GHz)
- ❑ DC power consumption : 36.9 mW at low gain mode
72 mW at high gain mode

Measured Output Spectrum for QPSK Signal

Low Gain Mode

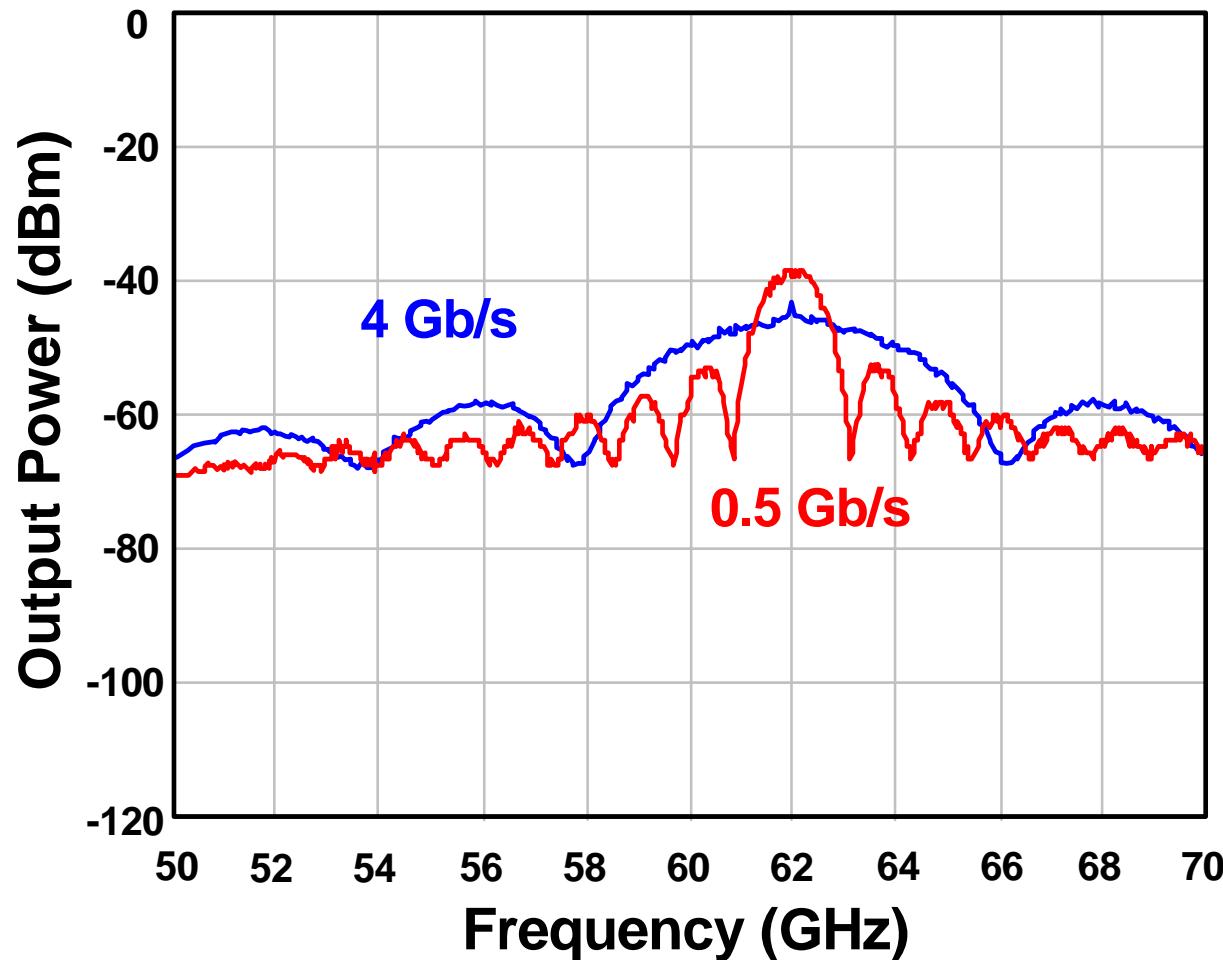


High Gain Mode



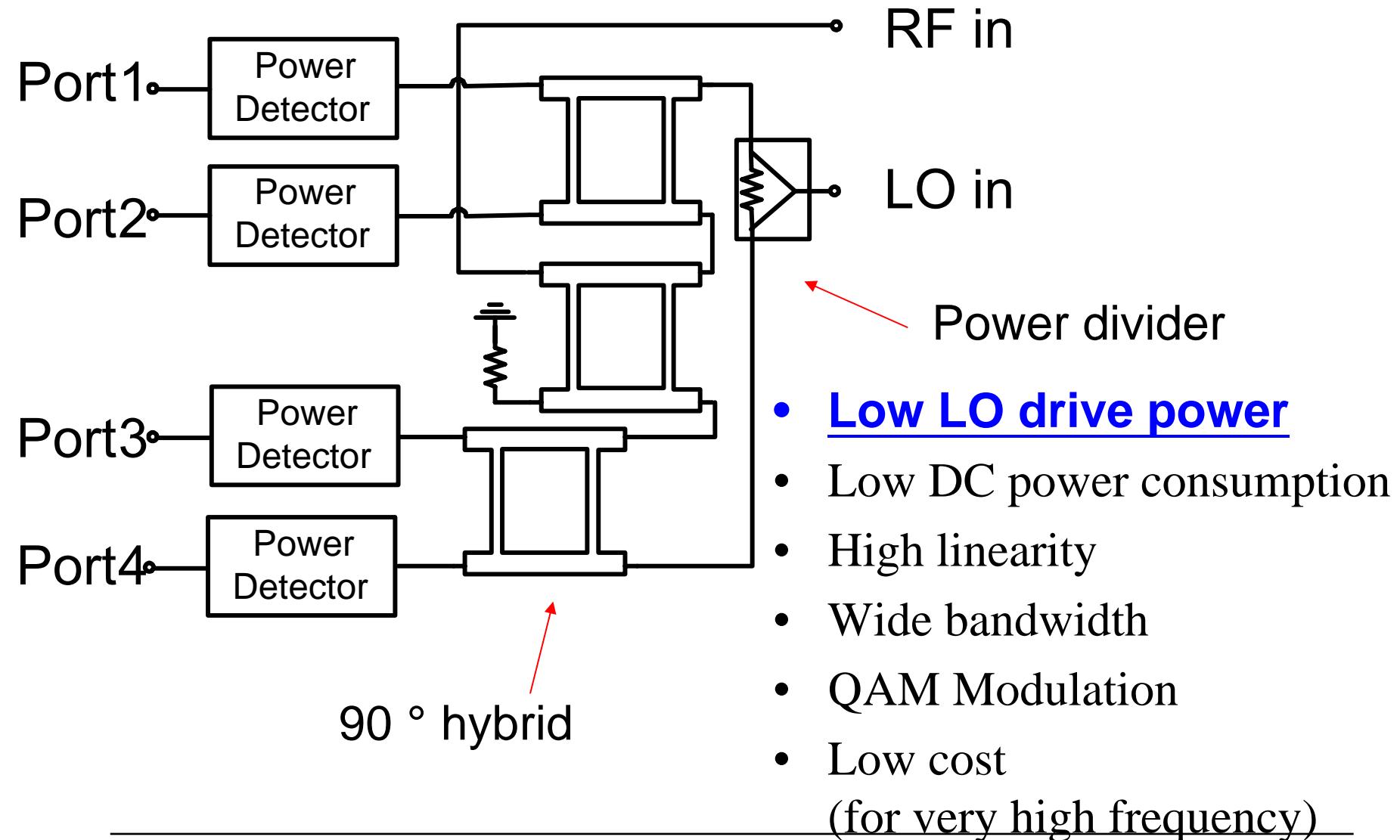
- Low gain mode : Image suppression > 30 dBc,
 LO suppression > 20 dBc, $f_{LO} \pm 2f_{IF} > 30$ dBc,
 $f_{LO} \pm 3f_{IF} > 40$ dBc, (60 to 64 GHz)
- High gain mode : Image suppression > 35 dBc,
 LO suppression > 30 dBc, $f_{LO} \pm 2f_{IF} > 35$ dBc,
 $f_{LO} \pm 3f_{IF} > 40$ dBc, (60 to 64 GHz)

Measured Output Spectrum for BPSK Signal

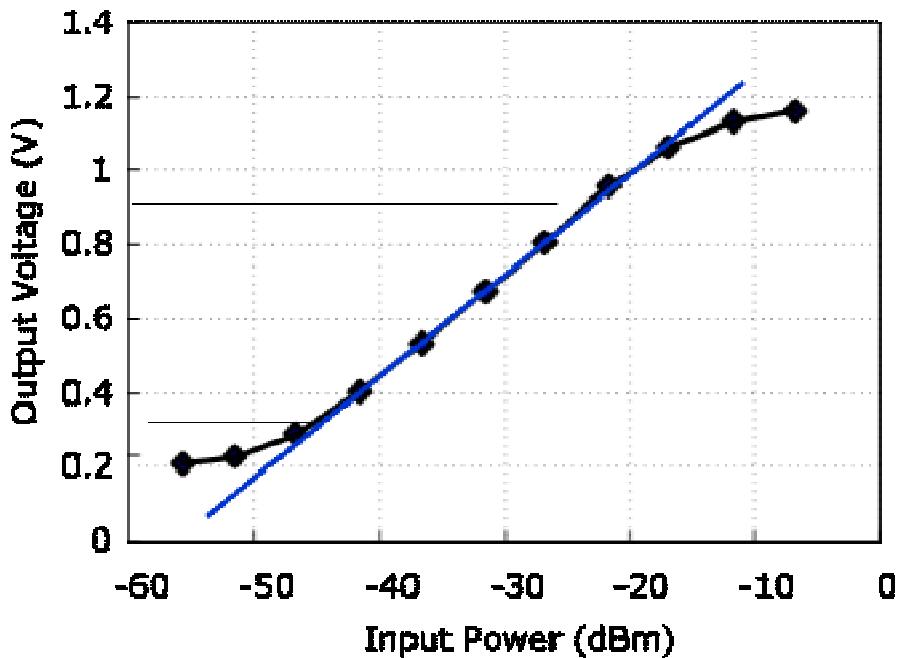
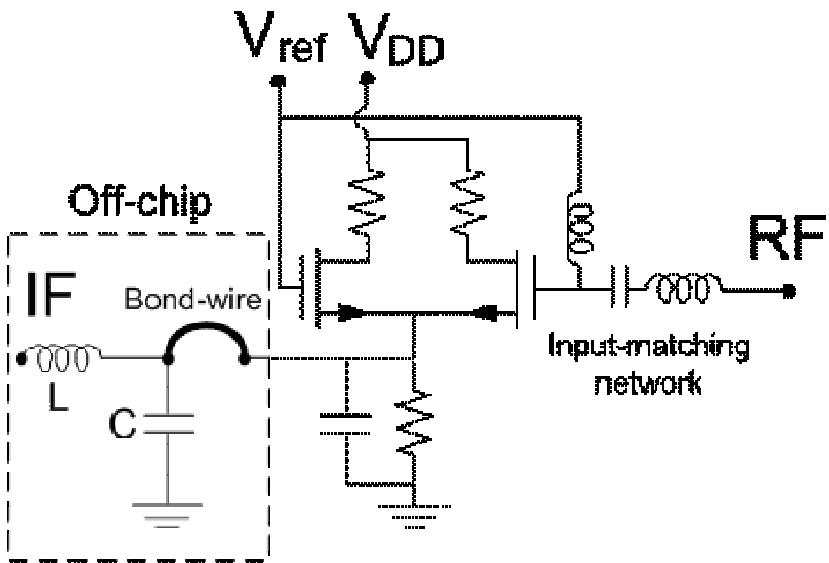


- ❑ Spectrum spread out due to unfiltered baseband signals

60 GHz Six-Port Reflectometer



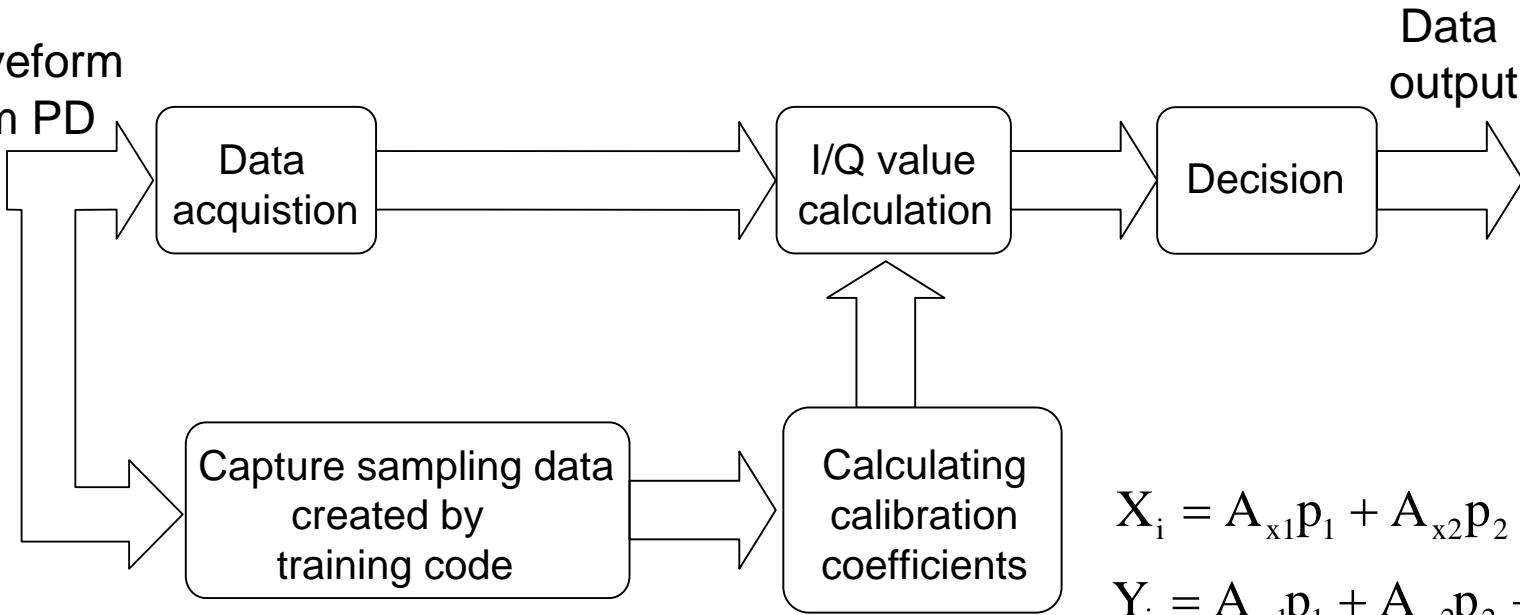
60 GHz Power Detector



- Input-matching network enhance sensitivity
- Sensitivity > 10000mV/mW (including LNA)
- V_{ref} set for maximum dynamic range
- Off-chip L and C values to achieve different modulation bandwidth

Real-Time Calibration Process

Waveform
from PD

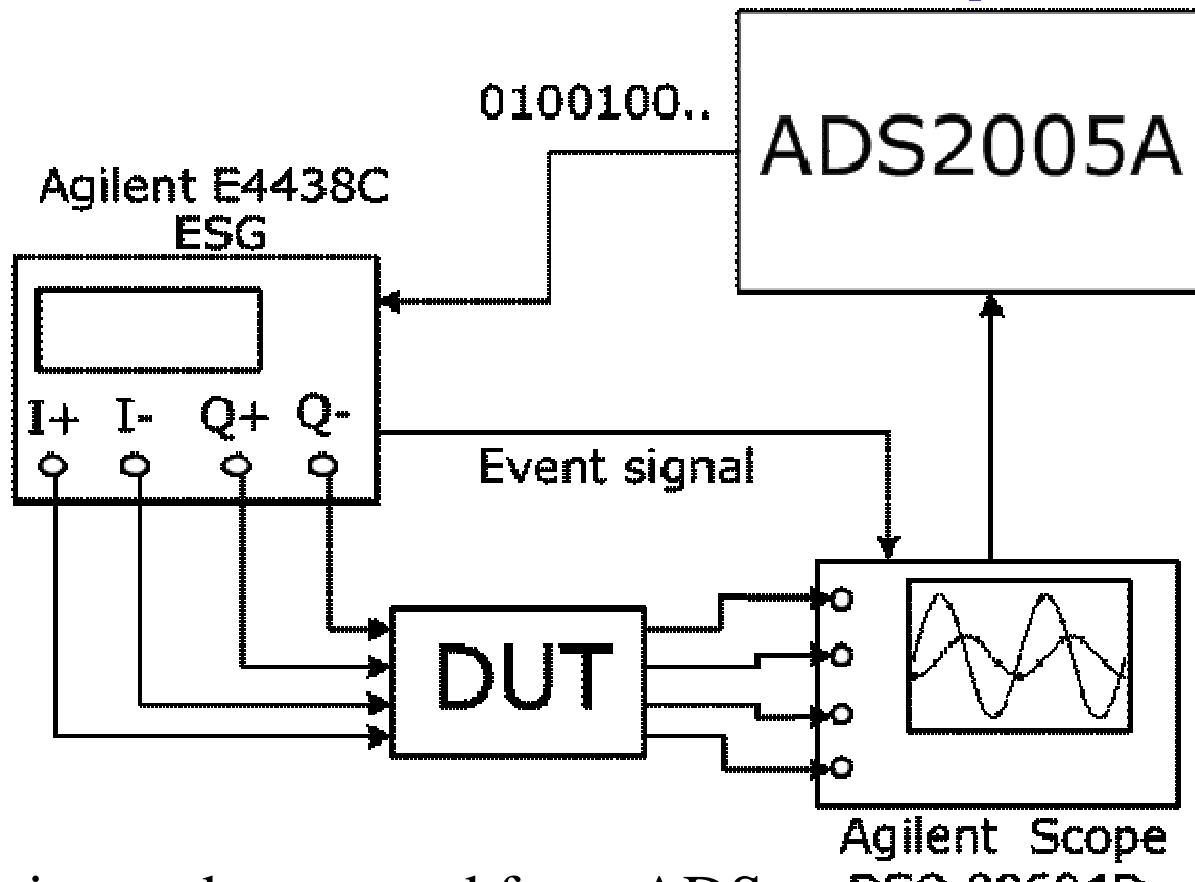


$$X_i = A_{x1}p_1 + A_{x2}p_2 + A_{x3}p_3 + C_x$$

$$Y_i = A_{y1}p_1 + A_{y2}p_2 + A_{y3}p_3 + C_y$$

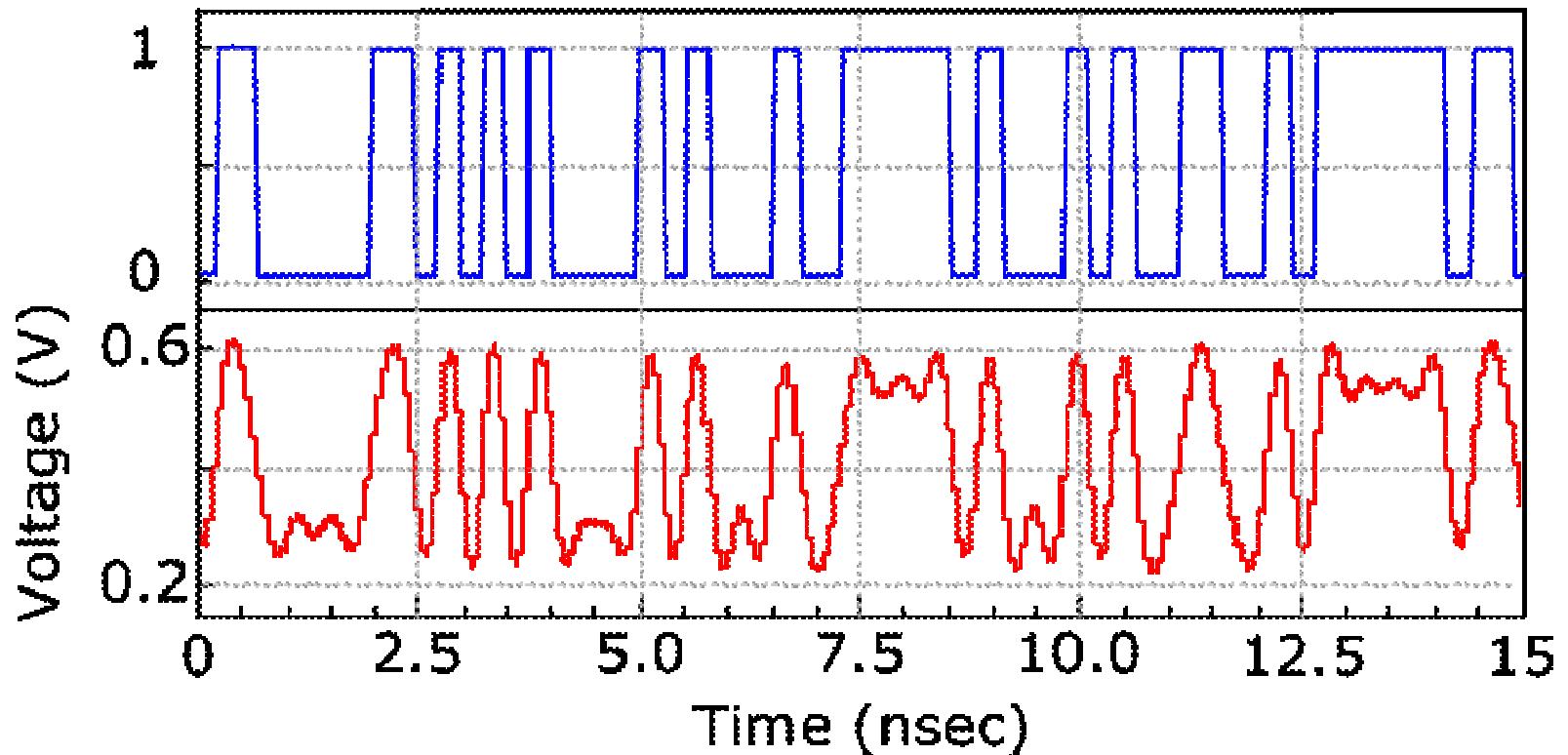
- ❑ X_i, Y_i : calculated output data
 A_{xi}, A_{yi}, C_x, C_y : calibration parameters to be determined
- ❑ $p1, p2, p3$: power ratios at the output detectors
- ❑ Known training code : calculate A_{xi}, A_{yi}, C_x , and C_y
- ❑ Non-ideal effects eliminated after real-time calibration process

Measurement Setup



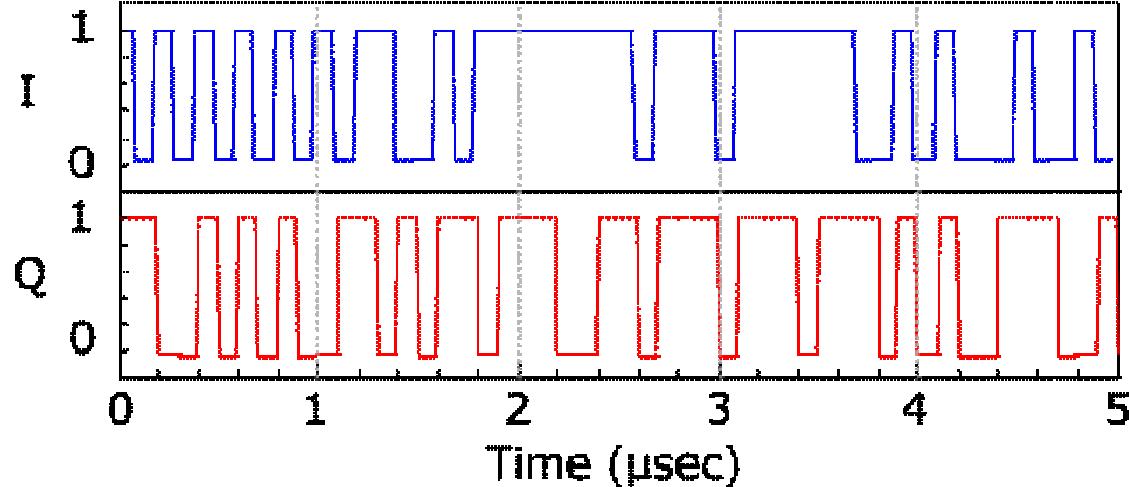
- Training code : created from ADS
- Capture waveform from real-time scope
- Instruments : controlled by ADS

Demodulation Results for BPSK Signal

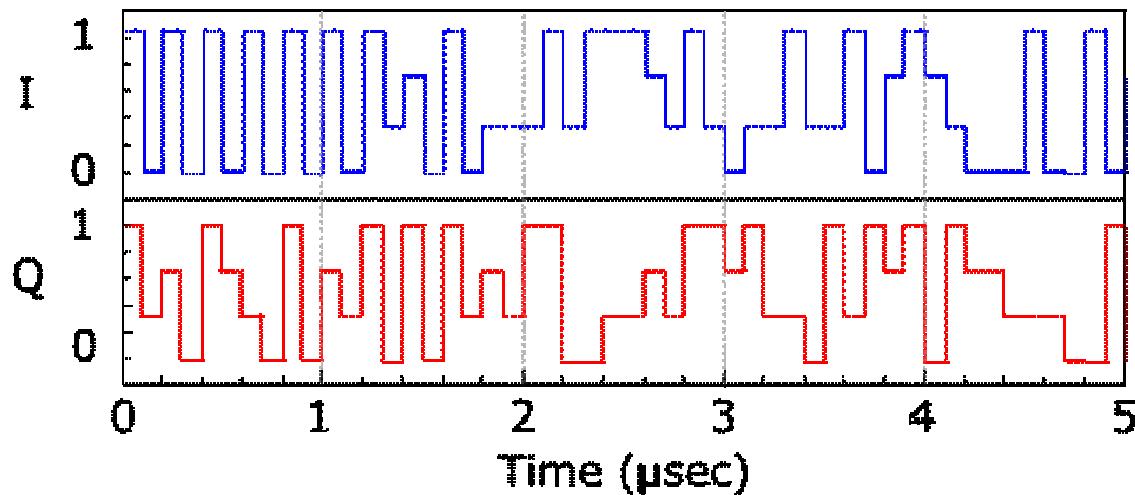


- ❑ Measured EVM of the 40Mb/s BPSK signal is lower than 4% with an input power of -30dB
- ❑ Data rate of BPSK modulation signals up to 4Gb/s

Demodulation Results for QPSK & 16QAM

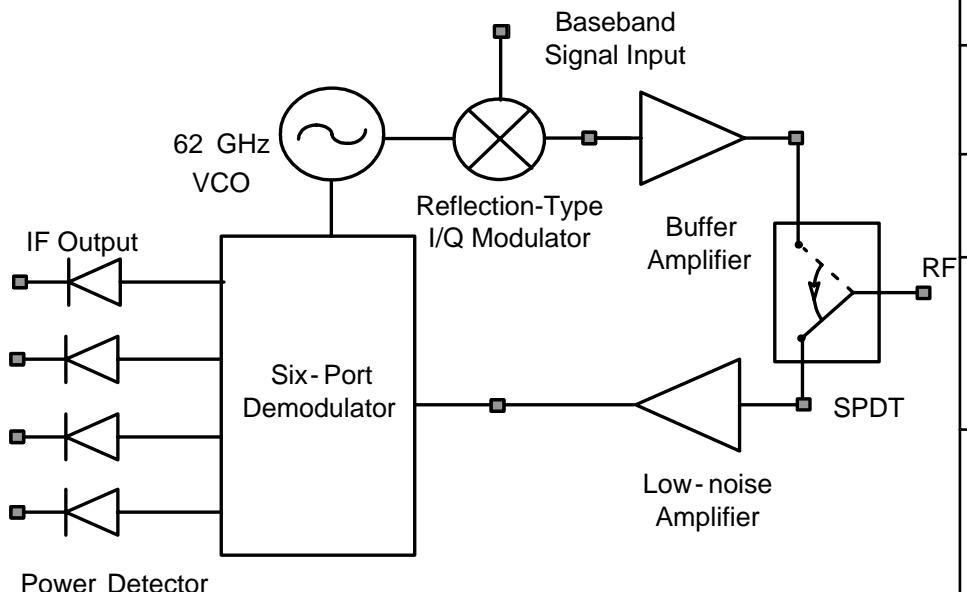


QPSK



16QAM

Performance Summary



- Tx : Reflection-type modulator
- Rx: Six-port reflectometer

Performance Summary	
Frequency (GHz)	60 ~ 67
Tx P_{out} (dBm)	-2
Rx min P_{in} (dBm) (no IF Amp)	-50
Rx NF (dB) (Simulated)	10
Modulation	QAM
VCO P_{out} (dBm)	> -10
DC Power Consumption (mW)	~ 97.9

25-75 GHz 90nm CMOS Gilbert-cell Mixer

Process : 90nm CMOS

Topology : Gilbert-cell

Chip size: 0.55 mm × 0.55 mm

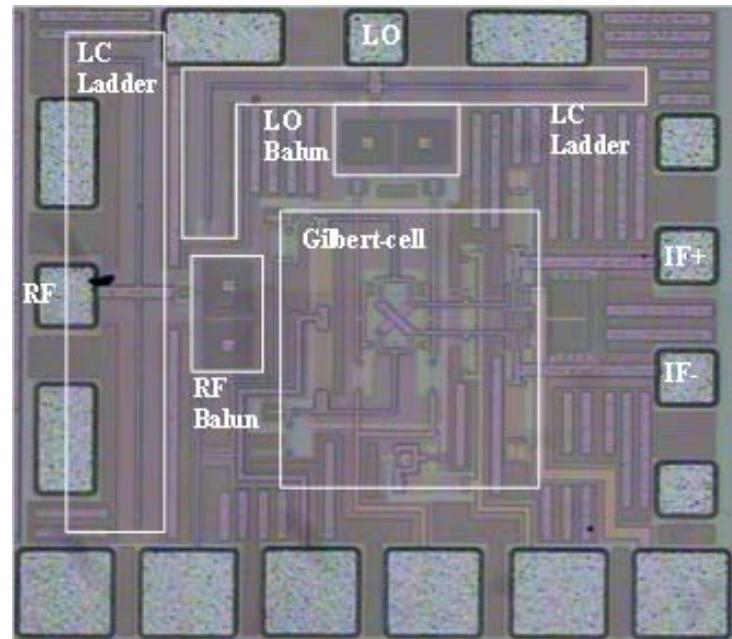
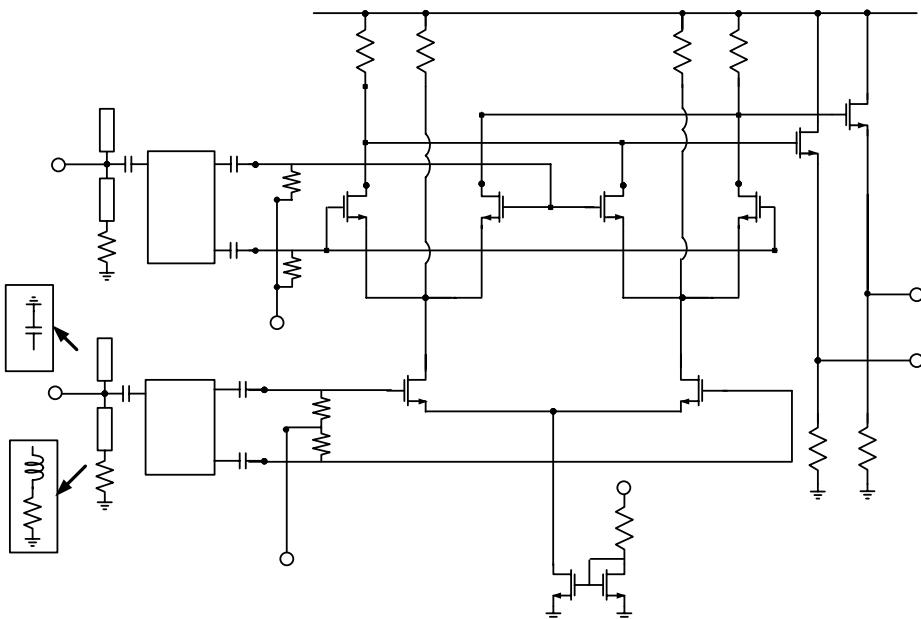
RF Frequency : 25-75 GHz

Conversion Gain : 3 ± 2 dB

LO Driver Power : 6 dBm

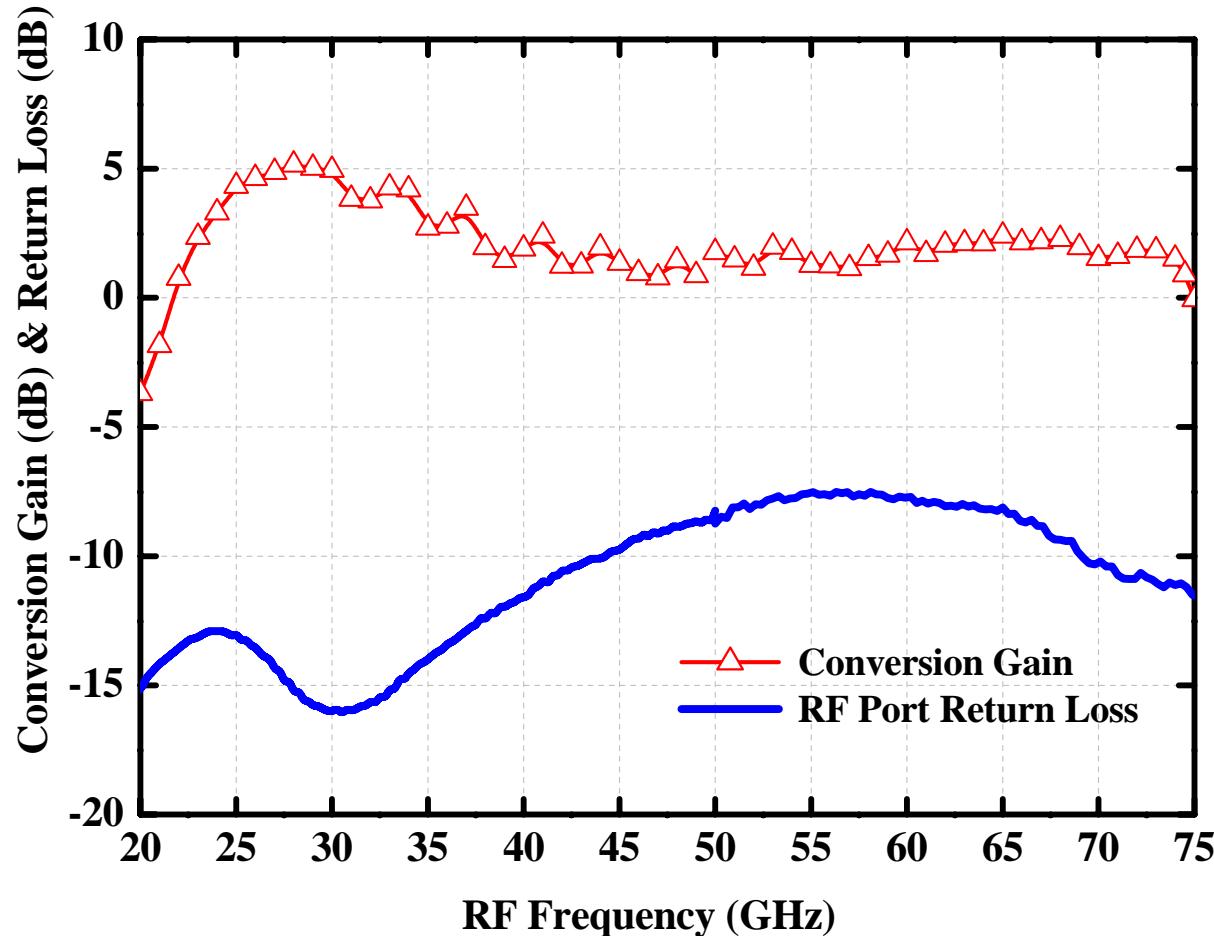
Power Consumption : 93 mW

Isolation : 30 dB

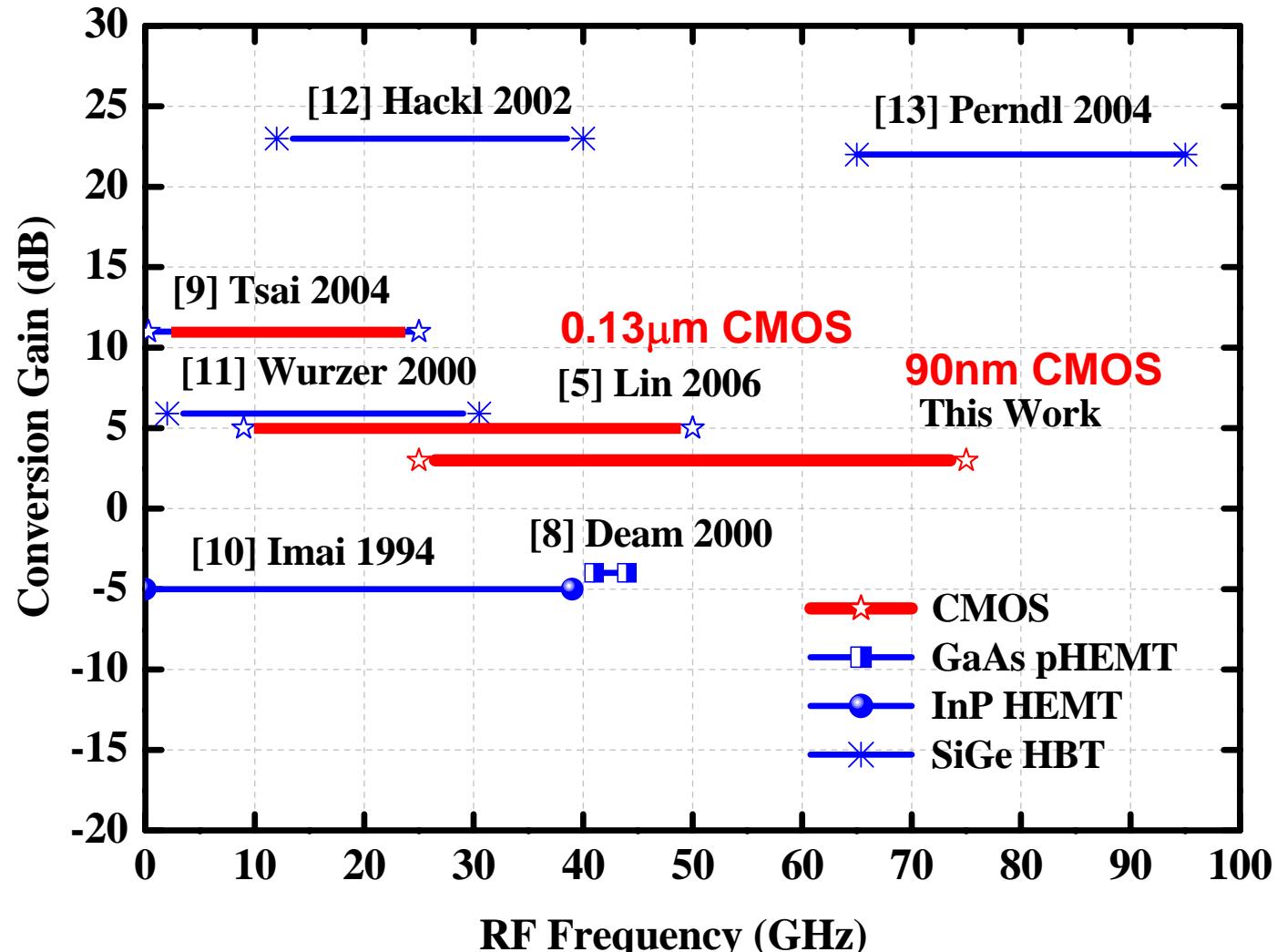


Jeng-Han Tsai, Pei-Si Wu, Chin-Shen Lin, Tian-Wei Huang, John G.J. Chern, and Wen-Chu Huang, "A 25-75-GHz Broadband Gilbert-cell Mixer Using 90-nm CMOS Technology," accepted by *IEEE Microwave and Guided Wave Letters*, April 2007.

Measurement Results



Conversion Gain and BW Comparison



LO Power and Chip Size Comparison

Process	Design Topology	Bandwidth (GHz)	Conversion Gain (dB)	LO Power (dBm)	Chip Size (mm ²)	Ref.
GaAs pHEMT	Fundamental Gilbert Cell	41-44	-4	0	1.7	[8]
GaAs pHEMT	Subharminic Resistive Gate-Pumped	39-48	-12.5 ± 1.5	5	0.72	2007 APMC
90-nm SOI CMOS	Fundamental Resistive Gate-Pumped	26.5-30	-10.3	0	0.121	2005 /08 TMTT
0.13-μm CMOS	Fundamental Resistive Gate-Pumped	~ 60	-2	0	n/a	2007 ISSCC
0.13-μm CMOS	Fundamental Gilbert Cell	9 - 50	+5	5	0.25	[5]
90-nm CMOS	Fundamental Gilbert Cell	25 - 75	+3 (± 2)	6	0.3	This Work

Summary

- Presented a 60-GHz six-port transceiver IC in standard-bulk 0.13μm CMOS technology.
- Presented a 25-75 GHz Gilbert-cell mixer in standard-bulk 90nm CMOS technology.
- 60-GHz LO power level in 0.13μm CMOS is a key factor for chip size and cost.

Thank you!